# SiSS12DN

RoHS

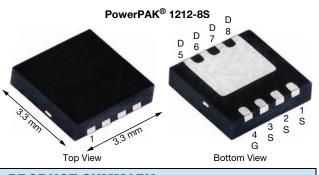
COMPLIANT HALOGEN

FREE

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**Vishay Siliconix** 

## N-Channel 40 V (D-S) MOSFET



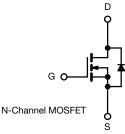
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	40				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.00198				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 4.5 V	0.00274				
Q <sub>g</sub> typ. (nC)	28.7				
I <sub>D</sub> (A)	60 <sup>a, g</sup>				
Configuration	Single				

#### **FEATURES**

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- Very low R<sub>DS(on)</sub> in a compact and thermally enhanced package
- Optimized Q<sub>g</sub>, Q<sub>gd</sub>, and Q<sub>gd</sub>/Q<sub>gs</sub> ratio reduces switching related power loss
- 100 % R<sub>a</sub> and UIS tested
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Synchronous rectification
- Synchronous buck converter
- High power density DC/DC
- OR-ing
- Load switching



ORDERING INFORMATION	
Package	PowerPAK 1212-8S
Lead (Pb)-free and halogen-free	SiSS12DN-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	40		
Gate-source voltage		V <sub>GS</sub>	+20 / -16	V	
	T <sub>C</sub> = 25 °C		60 <sup>a</sup>		
Continuous durin current (T. 150.00)	T <sub>C</sub> = 70 °C		60 <sup>a</sup>		
Continuous drain current ( $T_J = 150 \ ^\circ C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	37.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	30 <sup>b, c</sup>	•	
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	200	A	
Or artigeness of the standard second	T <sub>C</sub> = 25 °C		59.7		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	4.5 <sup>b, c</sup>		
Single pulse avalanche current		I <sub>AS</sub>	30		
Single pulse avalanche energy $L = 0.1 \text{ mH}$		E <sub>AS</sub>	45	mJ	
	T <sub>C</sub> = 25 °C		65.7		
	T <sub>C</sub> = 70 °C		42	10/	
Maximum power dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	5 b, c	W	
	T <sub>A</sub> = 70 °C	1	3.2 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	*0	
Soldering recommendations (peak temperature) <sup>c</sup>			260	°C	

#### THERMAL RESISTANCE BATINGS

THENMAE RESISTANCE RAT	NGS				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b	t ≤ 10 s	R <sub>thJA</sub>	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.5	1.9	0/10

#### Notes

Package limited a.

b. Surface mounted on 1" x 1" FR4 board

t = 10 s c.

See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 63 °C/W d.

e.

f.

g.  $T_C = 25 \ ^{\circ}C$ 

S18-0118-Rev. A, 29-Jan-18

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SiSS12DN

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			•	•		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V$ , $I_{D} = 250 \mu A$	40	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	22	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-6.3	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.1	-	2.4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = +20, -16 V$	-	-	± 100	nA
Zaus sata valta na slusia suuraat		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	
Zero gate voltage drain current	IDSS	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	10	μΑ
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5$ V, $V_{GS}$ = 10 V	30	-	-	Α
	P	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.00161	0.00198	0
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$	-	0.00230	0.00274	Ω
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	151	-	S
Dynamic <sup>b</sup>	· ·					
Input capacitance	C <sub>iss</sub>		-	4270	-	
Output capacitance	C <sub>oss</sub>		-	680	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	$V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHZ$	-	90	-	
C <sub>rss</sub> /C <sub>iss</sub> ratio			-	0.021	0.042	
Talala ale ale an		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$	-	59	89	
Total gate charge	Qg		-	28.7	43	
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	10.2	-	nC
Gate-drain charge	Q <sub>gd</sub>		-	7.6	-	
Output charge	Q <sub>oss</sub>	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	28	-	
Gate resistance	R <sub>q</sub>	f = 1 MHz	0.2	1	2	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	15	30	
Rise time	tr	$V_{DD} = 20 V, R_I = 1 \Omega$	-	27	60	
Turn-off delay time	t <sub>d(off)</sub>	$\begin{split} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A \\ & I_D = 250 \ \mu A \\ & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ & V_{DS} = 0 \ V, \ V_{GS} = 250 \ \mu A \\ & V_{DS} = 0 \ V, \ V_{GS} = +20, \ -16 \ V \\ & V_{DS} = 40 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^\circ C \\ & V_{DS} = 40 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^\circ C \\ & V_{DS} = 20 \ V, \ V_{GS} = 10 \ V \\ & V_{DS} = 10 \ V, \ I_D = 10 \ A \\ & V_{DS} = 10 \ V, \ I_D = 20 \ A \\ & V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ & V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10 \ A \\ & V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10 \ A \\ & V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10 \ A \\ & V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10 \ A \\ & V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 10 \ A \\ & V_{DS} = 20 \ V, \ V_{GS} = 0 \ V \\ & f = 1 \ MHz \end{split}$	-	28	60	
Fall time	t <sub>f</sub>		-	10	20	
Turn-on delay time	t <sub>d(on)</sub>		-	28	60	ns
Rise time	tr	$V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 1 \Omega$	-	66	140	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ Å},  \text{V}_{\text{GEN}} = 4.5 \text{ V},  \text{R}_{\text{g}} = 1  \Omega$	-	34	70	
Fall time	t <sub>f</sub>		-	22	45	
Drain-Source Body Diode Characteristic	s		1		1 1	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	60	
Pulse diode forward current ( $t_p = 100 \ \mu s$ )	I <sub>SM</sub>		-	-	200	A
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A	-	0.72	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>	-	-	45	90	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/us.	-	45	90	nC
Reverse recovery fall time	t <sub>a</sub>		-	22	-	
Reverse recovery rise time	t <sub>b</sub>		-	23	-	ns

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

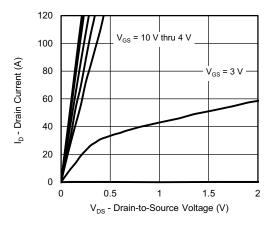
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

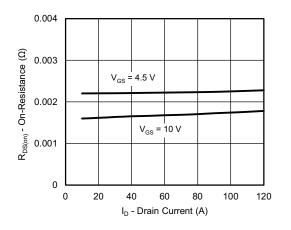
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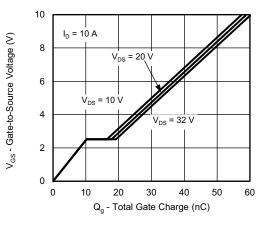
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



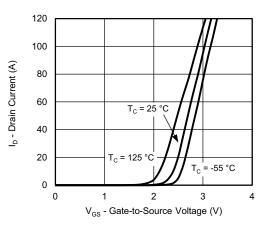
**Output Characteristics** 



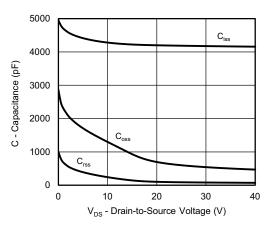
**On-Resistance vs. Drain Current** 



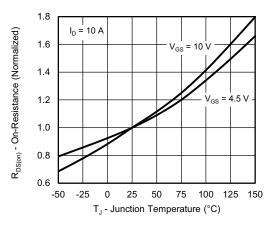
Gate Charge



**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

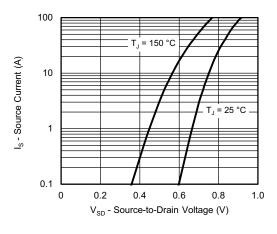
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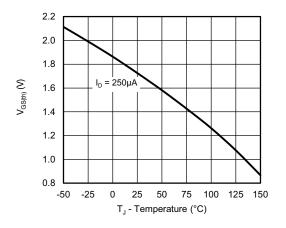
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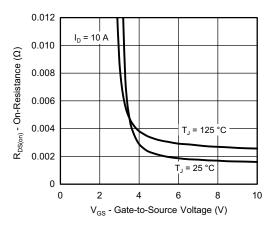
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



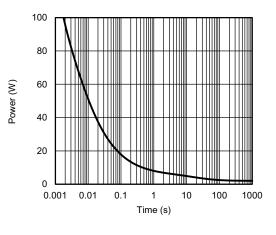
Source-Drain Diode Forward Voltage



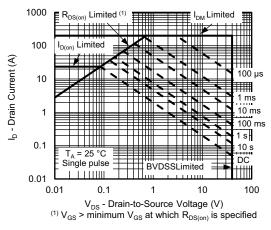
**Threshold Voltage** 



**On-Resistance vs. Gate-to-Source Voltage** 



Single Pulse Power, Junction-to-Ambient



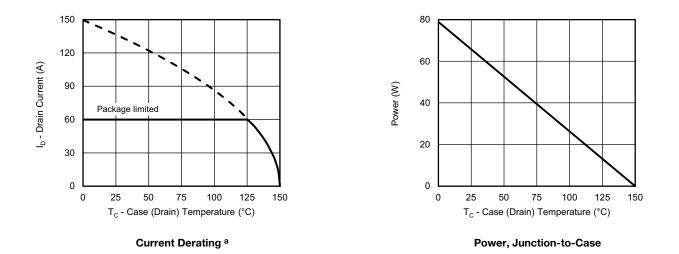
Safe Operating Area

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### Note

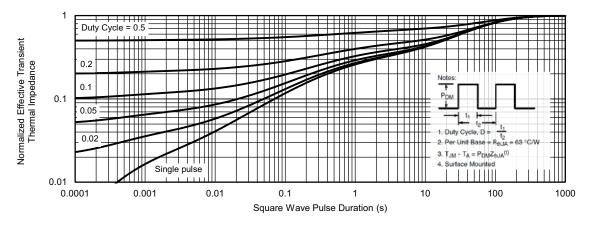
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



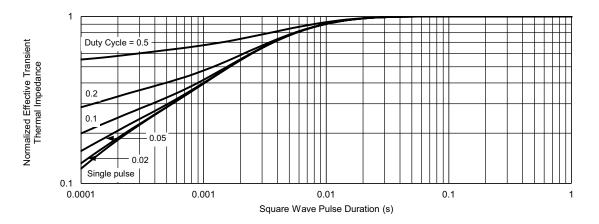
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

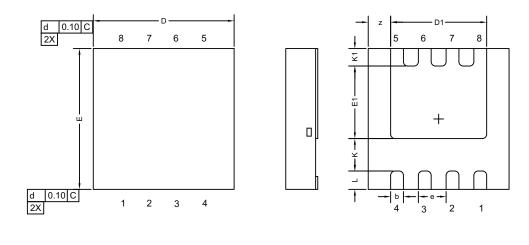


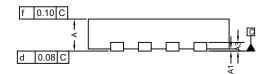
Normalized Thermal Transient Impedance, Junction-to-Case

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## Case Outline for PowerPAK<sup>®</sup> 1212-8S





DIM.		MILLIMETERS			INCHES			
DINI.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.67	0.75	0.83	0.027	0.030	0.033		
A1	0	-	0.05	0	-	0.002		
A3	0.20 REF			0.008 REF				
b		0.30 BSC			0.012 BSC			
D	3.30 BSC		0.130 BSC					
D1	2.15	2.25	2.35	0.084	0.088	0.092		
E		3.30 BSC		0.130 BSC				
E1	1.60	1.70	1.80	0.063	0.067	0.071		
е		0.65 BSC		0.026 BSC				
К		0.76 TYP		0.030 TYP				
K1		0.41 TYP		0.016 TYP				
L		0.43 BSC		0.017 BSC				
Z		0.525 TYP		0.021 TYP				

Note

• Millimeters will govern.



## RECOMMENDED MINIMUM PADS FOR PowerPAK<sup>®</sup> 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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